SQJ181ELP

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Automotive P-Channel 80 V (D-S) 175 °C MOSFET

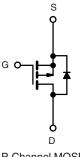


PRODUCT SUMMARY				
V _{DS} (V)	-80			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.0138			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0204			
I _D (A)	-128			
Configuration	Single			
Package	PowerPAK SO-8L			

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	-80	V		
Gate-source voltage ^a		V _{GS} ± 20		V		
Continuous drain current	T _C = 25 °C ^b	I	-128			
Continuous drain current	T _C = 125 °C	I _D	-74			
Continuous source current (diode conduction) b		I _S	-133	А		
Pulsed drain current ^c		I _{DM}	-224			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-47			
Single pulse avalanche energy		E _{AS}	110	mJ		
Maximum power dissipation ^c	T _C = 25 °C	PD	468	W		
	T _C = 125 °C	гD	156	vv		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C		
Soldering recommendations (peak temperature) d, e			260	C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^e	R _{thJA}	46	°C/W	
Junction-to-case (drain)	on-to-case (drain)		0.32	0/10	

Notes

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- b. Package limited
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = -250 \ \mu A$		-80	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = -250 μA		-2.0	-2.5	V	
Gate-source leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = -80 V	-	-	-1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -80 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	-50	μA	
		$V_{GS} = 0 V$	V _{DS} = -80 V, T _J = 175 °C	-	-	-150		
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge -5 V$	-30	-	-	А	
		V _{GS} = -10 V	I _D = -10 A	-	0.01	0.0138		
Durin an un state un interne 3	P	V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.234	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	l _D = -10 A, T _J = 175 °C	-	-	0.283		
		V _{GS} = -4.5 V	I _D = -8 A	-	0.0170	0.0204	1	
Forward transconductance b	9 _{fs}	V _{DS} =	-15 V, I _D = -10 A	-	35	-	S	
Dynamic ^b	•							
Input capacitance	C _{iss}		V _{DS} = -25 V, f = 1 MHz	-	4035	5649	pF	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	1774	2484		
Reverse transfer capacitance	C _{rss}			-	82	115		
Total gate charge ^c	Qg			-	59	89		
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{GS} = -10 V$ $V_{DS} = -40 V$, $I_{D} = -15 A$		15	-	nC	
Gate-drain charge ^c	Q _{gd}			-	7	-		
Gate resistance	Rg	f = 1 MHz		1.5	3.0	4.5	Ω	
Turn-on delay time ^c	t _{d(on)}				13	20	ns	
Rise time ^c	t _r	V_{DD} = -40 V, R _L = 2.66 Ω , I _D \cong -15 A, V _{GEN} = -10 V, R _g = 1 Ω		-	6	9		
Turn-off delay time ^c	t _{d(off)}			-	39	59		
Fall time ^c	t _f			-	8	12		
Source-Drain Diode Ratings and Chara	cteristics ^b							
Pulsed current ^a	I _{SM}			-	-	-224	А	
Forward voltage	V _{SD}	I _F = -10 A, V _{GS} = 0 V		-	-0.76	-1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = -10 A, di/dt = 100 A/μs		-	53	106	ns	
Body diode reverse recovery charge	Q _{rr}			-	87	174	nC	
Reverse recovery fall time	ta			-	27	-	ns	
Reverse recovery rise time	t _b			-	27	-		
Body diode peak reverse recovery	I _{RM(REC)}				-3		А	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

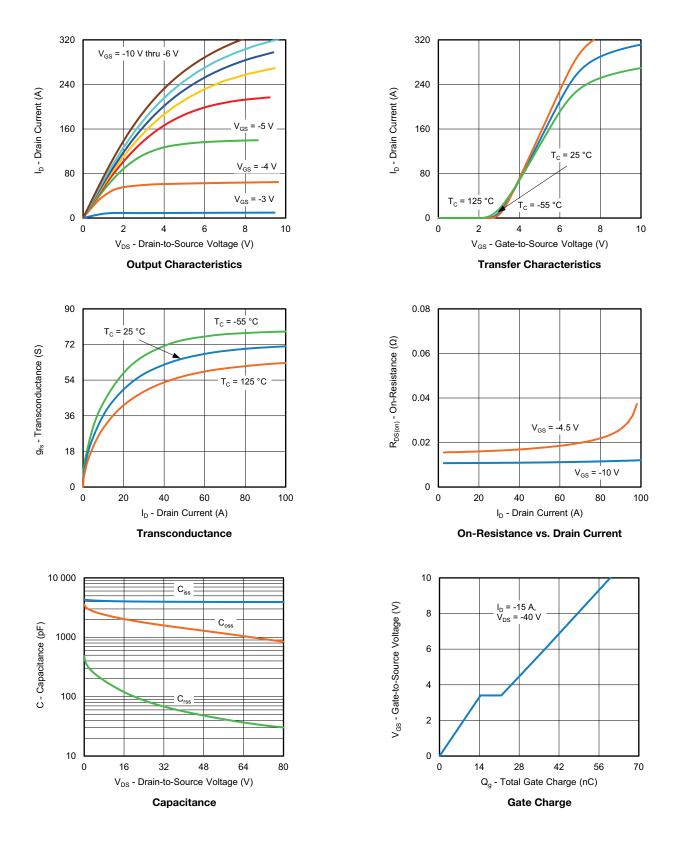
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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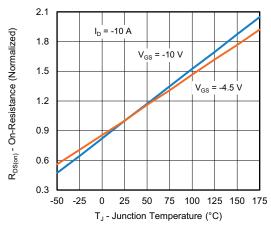
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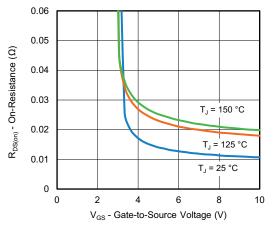
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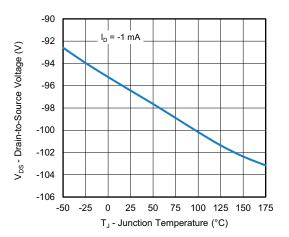
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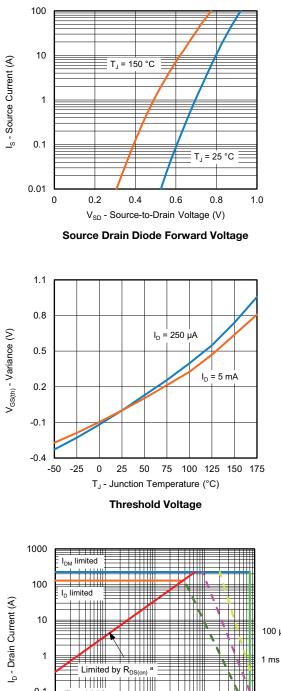
On-Resistance vs. Junction Temperature

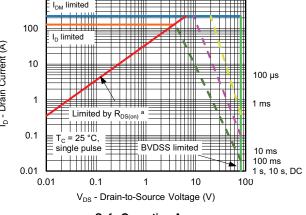


On-Resistance vs. Gate-to-Source Voltage

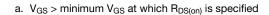


Drain-Source Breakdown vs. Junction Temperature





Safe Operating Area



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Note

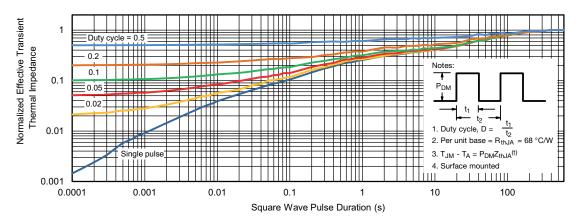
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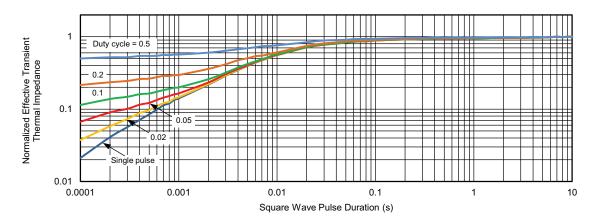


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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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